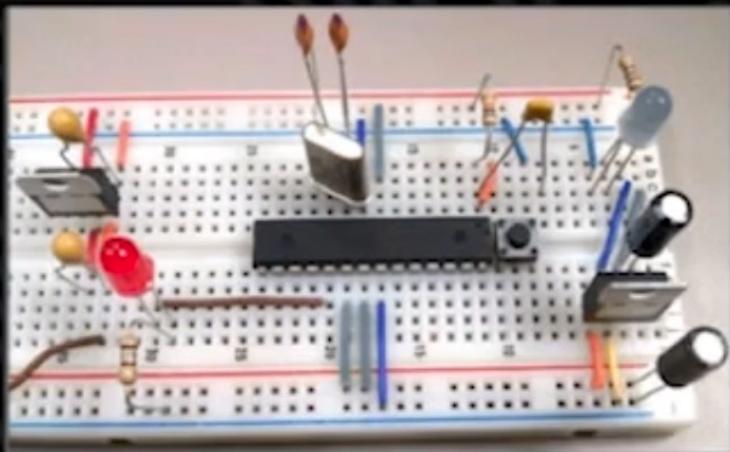


# Hardware and Software

# Hardware and Software

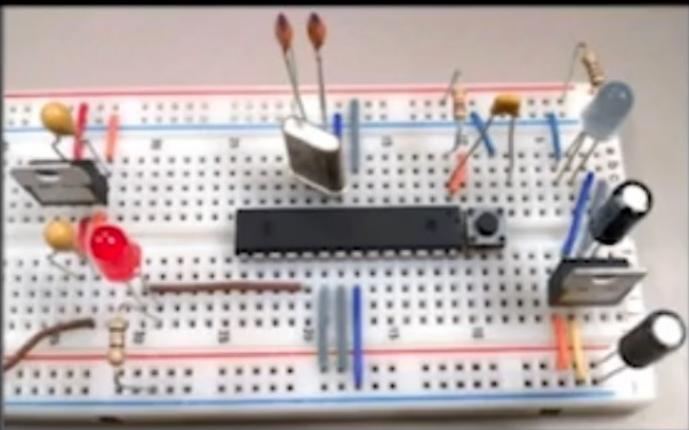
IoT devices are a combination of  
**hardware** and **software**



Hardware and software components  
must be designed together

# Hardware and Software

IoT devices are a combination of  
**hardware** and **software**



```
void loop() {  
    digitalWrite(13, HIGH);  
    delay(1000);  
    digitalWrite(13, LOW);  
    delay(1000);  
}
```

Hardware and software components  
must be designed together

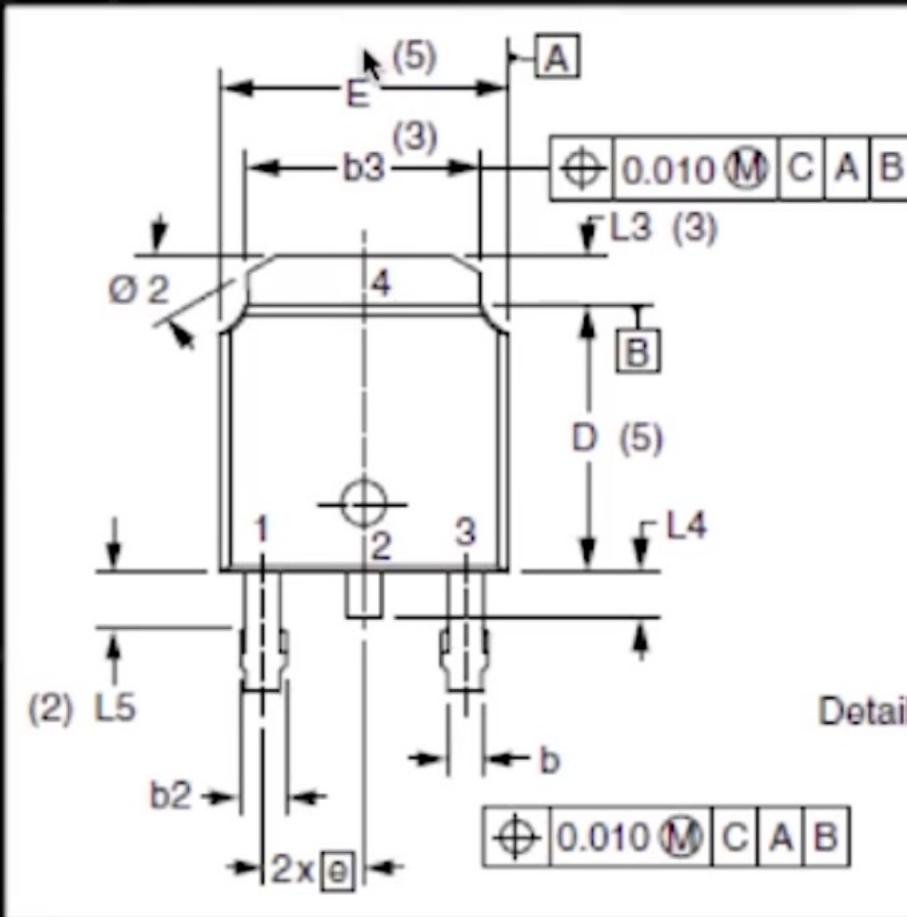
# Datasheets

**Datasheets** give details of each hardware component

- Physical size
- Input/output pins
- Electrical parameters  
(max current, etc.)

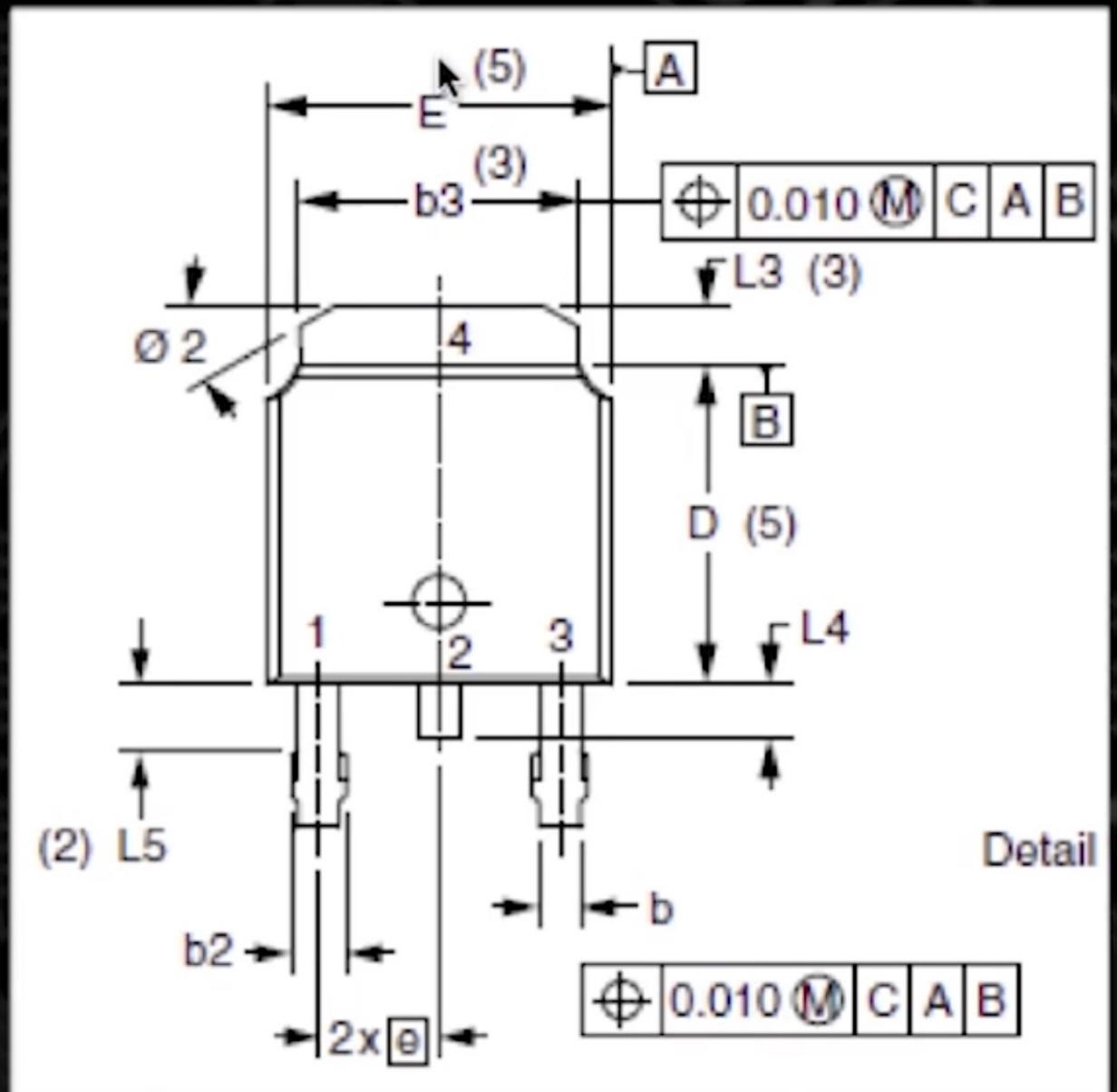
# Datasheet Example

## Schottky Rectifier



Size specifications  
for manufacturing

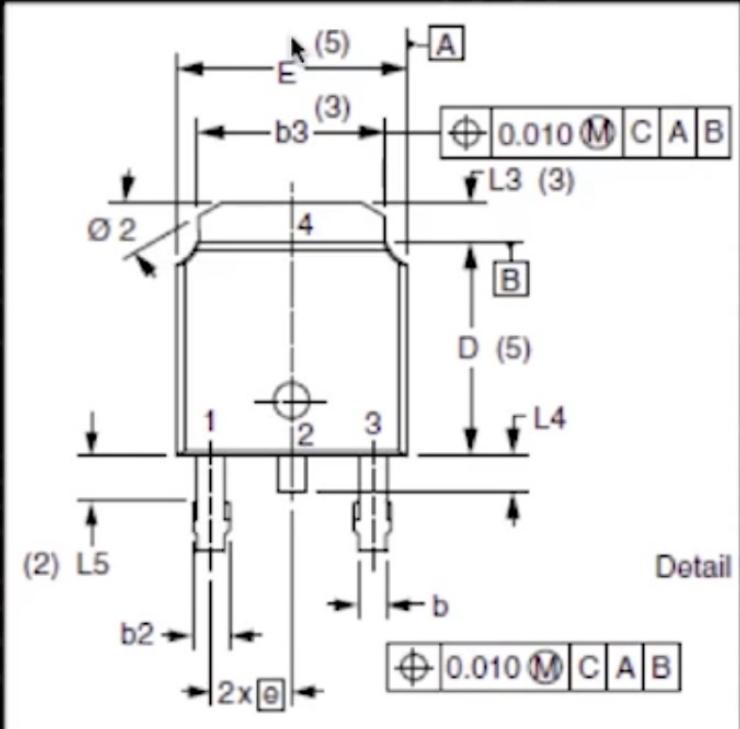
# Schottky Rectifier



Size specifications  
for manufacturing

# Datasheet Example

## Schottky Rectifier



Size specifications  
for manufacturing

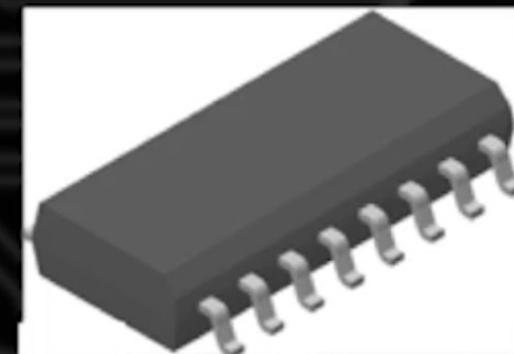
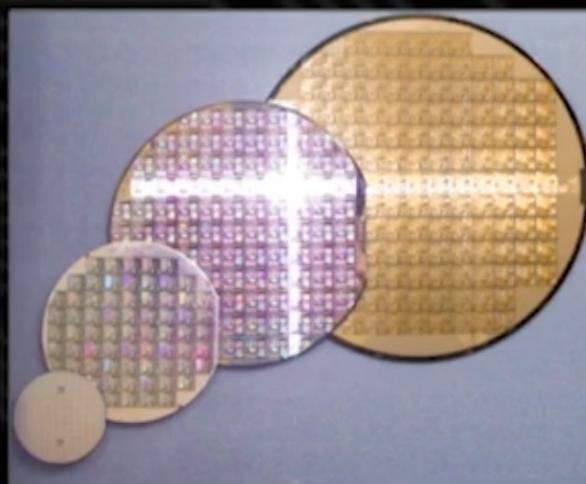
Electrical and thermal  
parameters

### ELECTRICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop per leg See fig. 1	$V_{FM}^{(1)}$	6 A	$T_J = 25 \text{ }^\circ\text{C}$	0.80	V
		12 A		0.95	
		6 A	$T_J = 125 \text{ }^\circ\text{C}$	0.65	
		12 A		0.78	

# Integrated Circuits (ICs)

- A small electronic device made of a semiconductor material
  - Silicon, Gallium Arsenide, etc.
- Chip is protected by a package
- Package has a set of pins to allow chip access



"*Tai Ji Dian*" redirects here. For the Hall in the Forbidden City, see [Hall of the Supreme Principle](#).

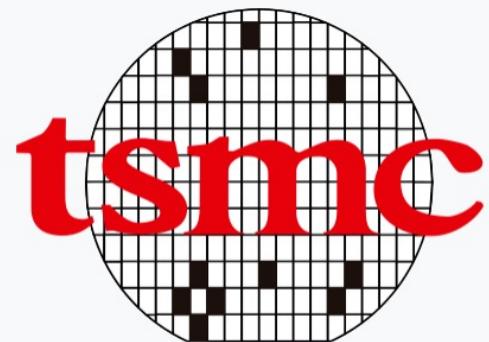
**Taiwan Semiconductor Manufacturing Company, Limited (TSMC)**; also called **Taiwan Semiconductor**)<sup>[4][5]</sup> is a Taiwanese [multinational semiconductor](#) contract manufacturing and design company. It is the world's most valuable semiconductor company,<sup>[6]</sup> the world's largest dedicated independent ([pure-play](#)) [semiconductor foundry](#),<sup>[7]</sup> and one of Taiwan's largest companies,<sup>[8][9]</sup> with its headquarters and main operations located in the [Hsinchu Science Park](#) in Hsinchu. It is majority owned by foreign investors.<sup>[10]</sup>

Founded in Taiwan in 1987 by [Morris Chang](#), TSMC was the world's first dedicated semiconductor foundry and has long been the leading company in its field.<sup>[11][12]</sup> When Chang retired in 2018, after 31 years of TSMC leadership, Mark Liu became Chairman and C. C. Wei became Chief Executive.<sup>[13][14]</sup> It has been listed on the [Taiwan Stock Exchange](#) (TWSE: 2330) since 1993; in 1997 it became the first Taiwanese company to be listed on the [New York Stock Exchange](#) (NYSE: TSM). Since 1994, TSMC has had a compound annual growth rate (CAGR) of 17.4% in revenue and a CAGR of 16.1% in earnings.<sup>[15]</sup>

Most of the leading [fabless](#) semiconductor companies such as [AMD](#), [Apple](#), [ARM](#), [Broadcom](#), [Marvell](#), [MediaTek](#), and [Nvidia](#), are customers of TSMC, as are emerging companies such as [Allwinner Technology](#), [HiSilicon](#), [Spectra7](#), and [Spreadtrum](#).<sup>[16]</sup> Leading [programmable logic device](#) companies [Xilinx](#) and previously [Altera](#) also make or made use of TSMC's foundry services.<sup>[17]</sup> Some [integrated device manufacturers](#) that have their own [fabrication facilities](#), such as [Intel](#), [NXP](#), [STMicroelectronics](#) and [Texas Instruments](#), outsource some of their production to TSMC.<sup>[18][19]</sup> At least one semiconductor company, [LSI](#), re-sells TSMC wafers through its [ASIC](#) design services and design IP portfolio.

TSMC has a global capacity of about thirteen million 300 mm-equivalent wafers per year as of 2020, and makes chips for customers with process nodes from 2 microns to [5 nanometres](#). TSMC is the first foundry to provide [7-nanometre](#) and [5-nanometre](#) (used by the 2020 [Apple A14](#) and [M1 SoC](#)) production capabilities, and the first to commercialize extreme [ultraviolet / EUV lithography](#) technology in high volume.

## Taiwan Semiconductor Manufacturing Company (TSMC) Ltd.



<b>Native name</b>	台灣積體電路製造股份有限公司
<b>Type</b>	Public
<b>Traded as</b>	TWSE: 2330 <a href="#">PDF</a> NYSE: TSM <a href="#">↗</a>
<b>ISIN</b>	US8740391003
<b>Industry</b>	Semiconductors GPUs Graphics cards Consumer electronics Computer hardware
<b>Founded</b>	Industrial Technology Research Institute.

# Microcontroller Characteristics

## Datapath Bitwidth

- Number of bits in each register
- Determines accuracy and data throughput

## Input/Output Pins

- Need enough pins to support your application

## Performance

- Clock rates are slower than desktop

# Other Microcontroller Features

## Timers

- Needed for real-time applications

## Analog-to-Digital Converters

- Used to read input from analog sensors

## Low-power modes

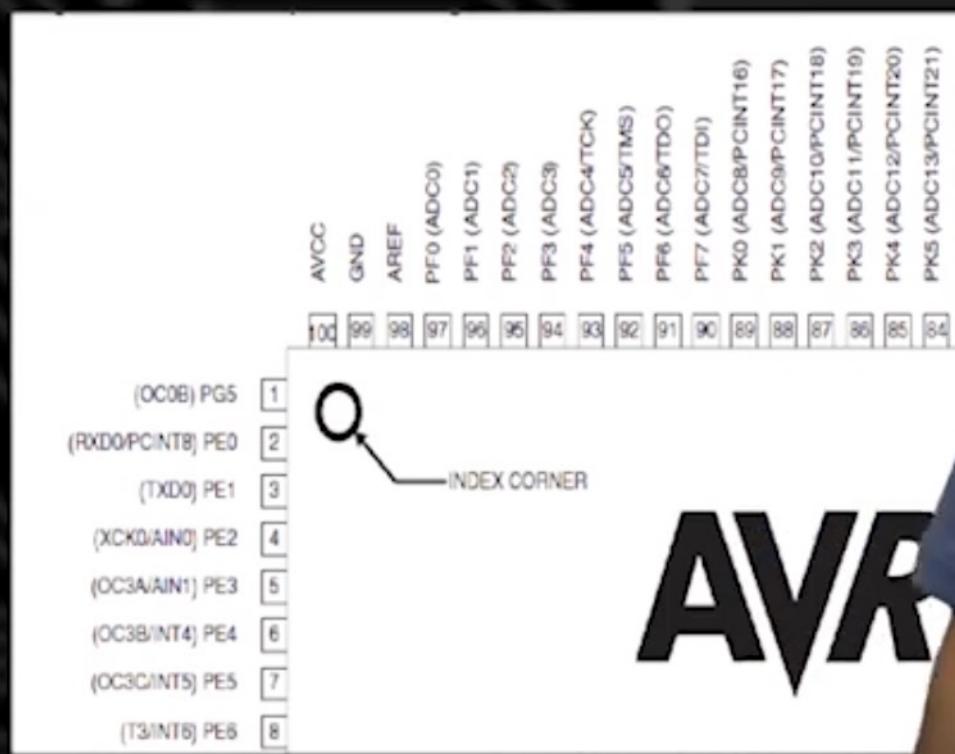
- Power saving is key

## Communication protocol support

- Interface with other ICs
- UART, I2C, SPI, etc.

# AVR ATmega2560

- 8-bit microcontroller
- Up to 16MHz
- 256KB of flash memory
- 4KB EEPROM, 8KB SRAM
- Peripherals



**AVR**

	1	(OC0B) PG5
	2	(RXD0/PCINT8) PE0
	3	(TXD0) PE1
	4	(XCK0/AIN0) PE2
	5	(OC3A/AIN1) PE3
	6	(OC3B/INT4) PE4
	7	(OC3C/INT5) PE5
	8	[T3/INT6] PE6



INDEX CORNER

AVCC	GND	AREF	PF0 (ADC0)	PF1 (ADC1)	PF2 (ADC2)	PF3 (ADC3)	PF4 (ADC4/TCK)	PF5 (ADC5/TMS)	PF6 (ADC6/TDO)	PF7 (ADC7/TDI)	PK0 (ADC8/PCINT16)	PK1 (ADC9/PCINT17)	PK2 (ADC10/PCINT18)	PK3 (ADC11/PCINT19)	PK4 (ADC12/PCINT20)	PK5 (ADC13/PCINT21)	PK6 (ADC14/PCINT22)	PK7 (ADC15/PCINT23)	GND
100	99	98	97	96	95	94	93	92	91	90	89	88	87	86	85	84	83	82	81

# AVR®

# Microcontroller Components

- Storage elements
  - Data stored in different components
  - Speed/Cost (area) tradeoff
- Register: stores a single value
  - Like a single memory location
  - Extremely fast & expensive
- Several special-purpose registers, used internally
- General-purpose registers, used by the program

# Storage Elements

- Register file: Stores many values
  - A set of registers; each has an address
  - Acts just like a memory
  - Extremely fast, expensive
- Instruction operands are here
  - `add $r3, $r2, $r1`
- Can only read one or two registers at a time
- May contain ~32 registers

# Memories

- **Cache:** Stores many values
  - Slower than a register file
  - Cheaper than a register file
  - Still fairly fast and expensive
- Data cache holds data that the program operates on
- Instruction cache holds program instructions

# Main Memory

- Very big: Gigabytes (Gb)
- Not in the CPU
- Connected to the CPU via **system bus**
- Memory access is slow

*Von Neumann Bottleneck:*

- Memory is much slower than the CPU



# Software Translation

- Machine language: CPU instructions represented in binary
- Assembly language: CPU instructions with mnemonics
  - Easier to read
  - Like machine language
- High-level language: commonly used languages (C, C++, Java)
  - Easier to use

# Compilation and Interpretation

- **Compilation:** translate instructions once before running the code
  - C, C++, Java (partially)
  - Translation occurs only once, saves time
- **Interpretation: translate instructions while code is executed**
  - Basic, Java (partially)
  - Translation occurs every execution
  - Translation can adapt to runtime situation

## Python vs C/C++

- Python is interpreted -- a scripting language
- Python is easier to work with, if speed is not primary

- Python is interpreted -- a scripting language
- Python is easier to work with, if speed is not primary



VS

- C and C++ are compiled
- C and C++ are more common for performance

**a = b + c;**

Compiler

lw \$r1, (\$s1) → Load b from memory  
lw \$r2, (\$s2) → Load c from memory  
add \$r3, \$r2, \$r1 → Add b and c  
sw \$r3, (\$s3) → Store result a in memory

Assembler

1001000100000011000000100000001

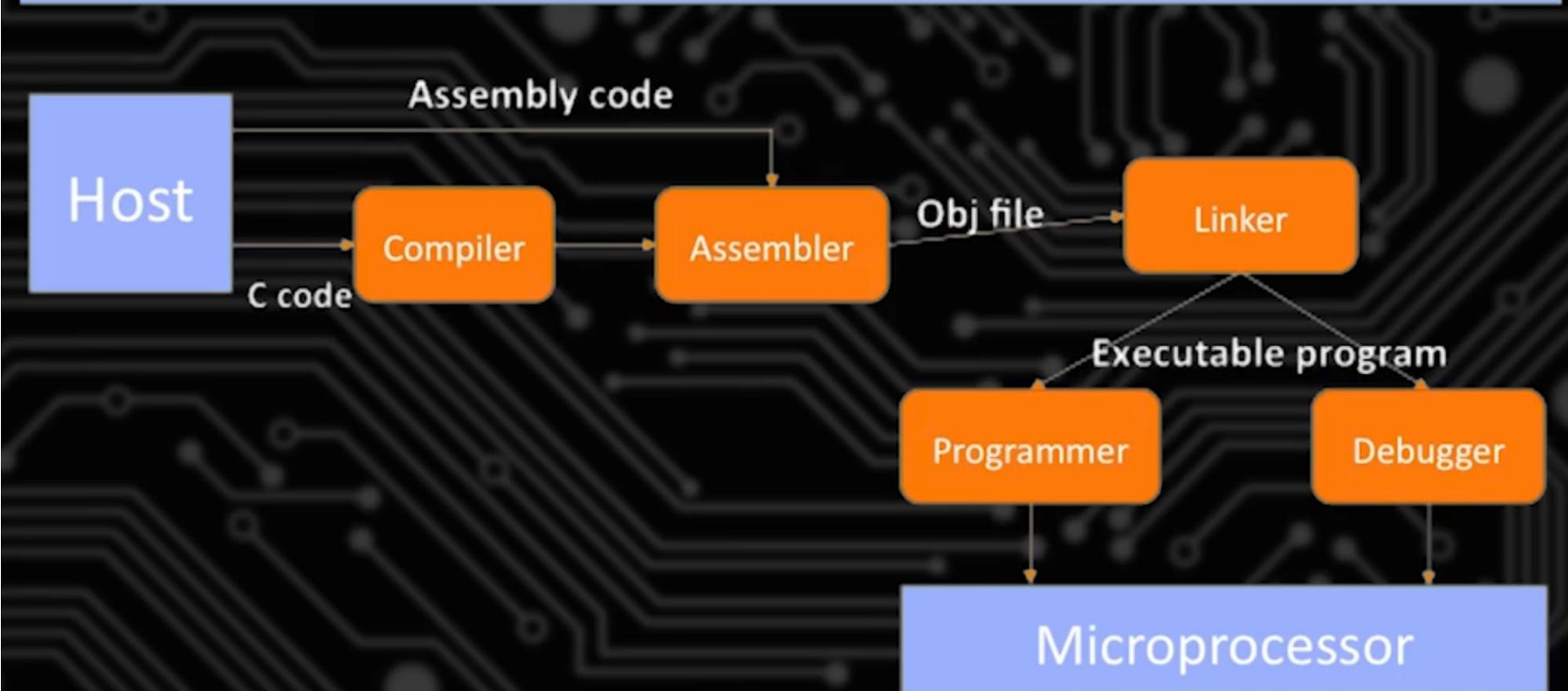
**add**

**\$r3**

**\$r2**

**\$r1**

# Software Tool Chain



- Software written on a host
- Transferred to the flash memory in the microcontroller
- Tool chain is the set of tools needed to process the software

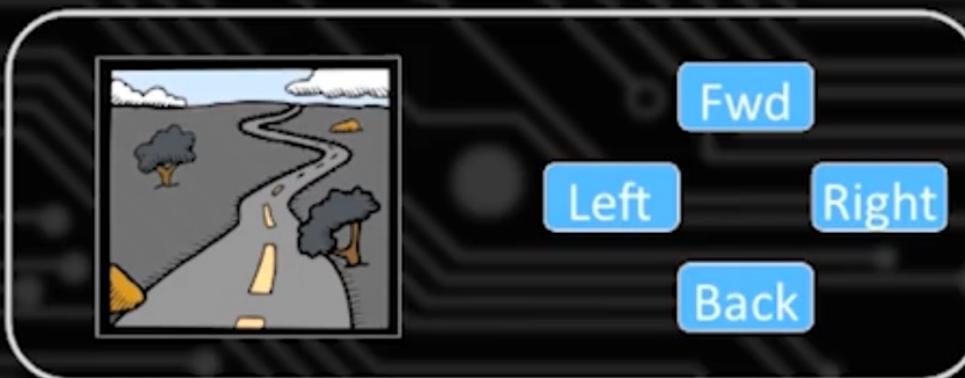
# Operating System

- Manages other programs
  - Windows, Linux, IOS, etc.
- Allows many programs to be executed together
- Incorporates a nice user interface
- Needs processing power and memory
- Slows down the system, makes development easier

# Operating System Example

Web-controlled car with a camera

- Car is controlled via the Internet
- Car has its own webserver (<http://mycar/>)
- Web interface allows user to control car and see camera images
- Car also has “auto brake” feature to avoid collisions



Web interface view

# Multiple Tasks

- Assume that one microcontroller is being used
  - At least four different tasks must be performed
1. **Send video data:** continuous while a user is connected
  2. **Service motion buttons :** whenever button is pressed, may last seconds
  3. **Detect obstacles:** continuous at all times
  4. **Auto brake:** whenever obstacle is detected, may last seconds

# Process/Task Support

- Main job of an OS is to support the **Process (Task) Abstraction**
- A **process** is an instantiation of a program; it must have access to:
  - the CPU
  - memory
  - other resources
    - I/O, ADC, timers, network, etc.
- OS must **manage resources**
  - Give processes fair access to the CPU
  - Give processes access to resources